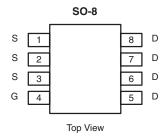


Vishay Siliconix

N-Channel 25-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
	0.0086 at V _{GS} = 10 V	18				
25	0.0095 at V _{GS} = 4.5 V	17	17.5 nC			
	0.0115 at V _{GS} = 2.5 V	15.5				



Ordering Information: Si4116DY-T1-E3 (Lead (Pb)-free)

Si4116DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

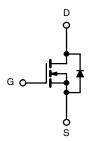
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

- Synchronous Buck
 - Low Side



ROHS
COMPLIANT
HALOGEN
FREE



N-Channel MOSFET

Parameter	Symbol	Limit	Unit V		
Drain-Source Voltage	V _{DS} V _{GS}	25			
Gate-Source Voltage		± 12	V		
	T _C = 25 °C		18		
Continuous Drain Current (T _{.I} = 150 °C)	$T_C = 70 ^{\circ}C$	l _n	14.3		
Continuous Diam Current (1) = 150 °C)	T _A = 25 °C	- I _D	12.7 ^{b, c}		
	T _A = 70 °C	1	10.1 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	50	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		4.5		
Continuous Source-Drain Diode Current	T _A = 25 °C	Is	2.2 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Avalanche Energy	L=0.1 IIII	E _{AS}	20	mJ	
	T _C = 25 °C		5		
Maximum Power Discinction	T _C = 70 °C	P _D	3.2	w	
Maximum Power Dissipation	T _A = 25 °C		2.5 ^{b, c}	VV	
	T _A = 70 °C	1	1.6 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	43	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	19	25	O/ VV		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 95 °C/W.

Si4116DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-				•		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050A		30		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{D} = 250 \mu A$		- 4.0			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	0.6		1.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
7 0	I _{DSS}	V _{DS} = 25 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 10 A		0.0071	0.0086		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0078	0.0095	5 Ω	
	, ,	$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		0.009	0.0115		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 10 \text{ A}$		68		S	
Dynamic ^b					l		
Input Capacitance	C _{iss}			1925		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		305			
Reverse Transfer Capacitance	C _{rss}			135			
· ·		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		37	56		
Total Gate Charge	Q_g	20 00 2		17.5	27	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		3.7			
Gate-Drain Charge	Q _{gd}			3.3			
Gate Resistance	R _g	f = 1 MHz		1.6	3.0	Ω	
Turn-On Delay Time	t _{d(on)}			13	25		
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		11	20		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω		50	90	1	
Fall Time	t _f			15	30		
Turn-On Delay Time	t _{d(on)}			7	14	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		10	20	<u> </u> - 	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		31	55		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristi	cs				l		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			4.5	•	
Pulse Diode Forward Current ^a	I _{SM}				50	Α	
Body Diode Voltage	V _{SD}	I _S = 3 A		0.69	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			26	45	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L 5A 41/41 400 4/ T 07 00		16	30	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		13		<u> </u>	
Reverse Recovery Rise Time	t _b			13		ns	

Notes

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

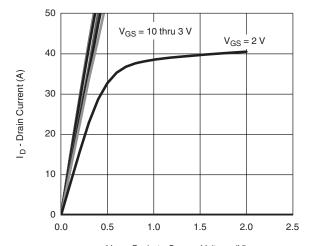
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.



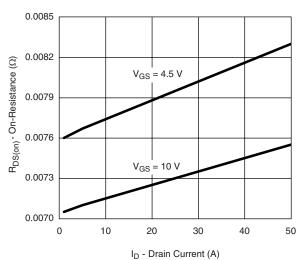
Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

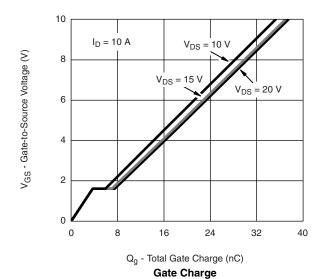


V_{DS} - Drain-to-Source Voltage (V)

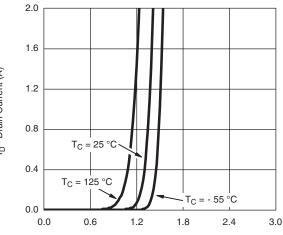
Output Characteristics



On-Resistance vs. Drain Current and Gate Voltage

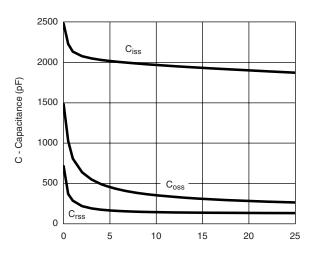


I_D - Drain Current (A)



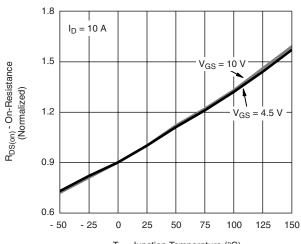
V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



V_{DS} - Drain-to-Source Voltage (V)

Capacitance



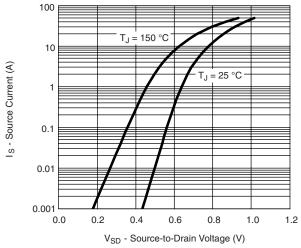
T_J - Junction Temperature (°C)

Si4116DY

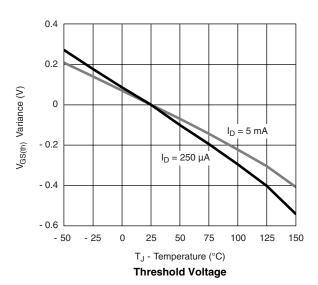
Vishay Siliconix

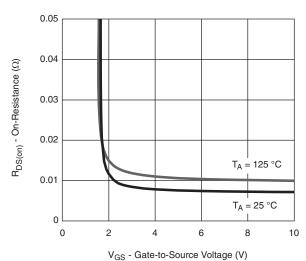
VISHAY.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

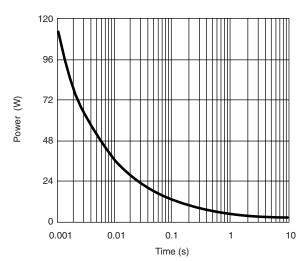


Source-Drain Diode Forward Voltage

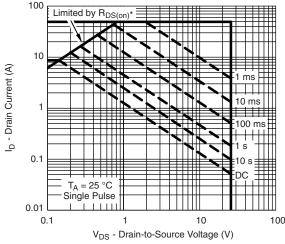




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



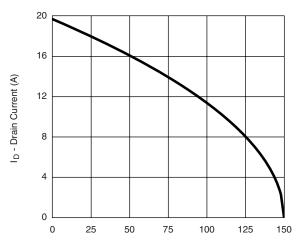
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient



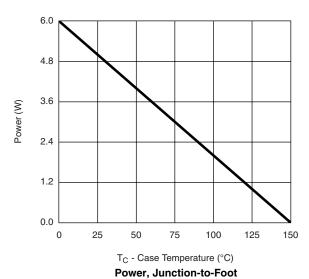
Si4116DY Vishay Siliconix

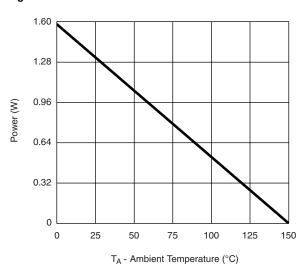
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





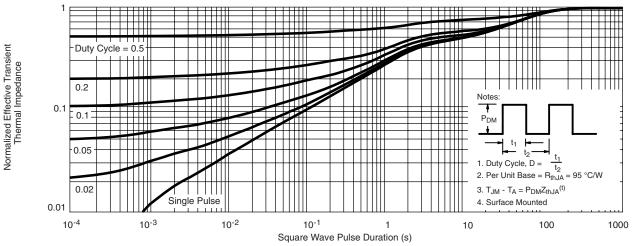
Power, Junction-to-Ambient

 $^{^*}$ The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

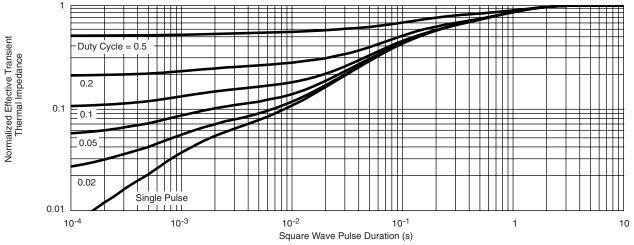
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?69837.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 13-Jun-16 1 Document Number: 91000